1 Characteristics

Table 1. Absolute ratings (limiting values at 25 °C, unless otherwise specified)

Symbol	Parameter		Value	Unit
V_{RRM}	Repetitive peak reverse voltage (Tj = -40 °C to +175 °C)		600	V
$I_{F(RMS)}$	Forward rms current		50	A
$I_{F(AV)}$	Average forward current δ = 0.5, square wave	T_c = 125 °C	30	A
I_{FSM}	Surge non repetitive forward current	t_p = 10 ms sinusoidal	300	A
T_{stg}	Storage temperature range		-65 to +175	°C
T_j	Operating junction temperature range		-40 to +175	°C

Table 2. Thermal resistance parameter

Symbol	Parameter	Max. value	Unit
$R_{th(j-c)}$	Junction to case	1.1	°C/W

For more information, please refer to the following application note :

- **AN5088** : Rectifiers thermal management, handling and mounting recommendations

Table 3. Static electrical characteristics

Symbol	Parameter	Test conditions		Min.	Typ.	Max.	Unit
I_R(1)	Reverse leakage current	T_j = 25 °C	$V_R = V_{RRM}$	-		25	µA
		T_j = 150 °C		-	80	800	
V_F(2)	Forward voltage drop	T_j = 25 °C	I_F = 30 A	-		1.55	V
		T_j = 150 °C		-	1.0	1.25	

1. *Pulse test: t_p = 5 ms, δ < 2%*
2. *Pulse test: t_p = 380 µs, δ < 2%*

To evaluate the conduction losses, use the following equation:

$P = 0.95 \times I_{F(AV)} + 0.010 \times I_F{}^2{}_{(RMS)}$

For more information, please refer to the following application notes related to the power losses :

- **AN604**: Calculation of conduction losses in a power rectifier
- **AN4021**: Calculation of reverse losses on a power diode
- **AN5028**: Calculation of turn-off power losses generated by an ultrafast diode

Table 4. Dynamic characteristics (T_j = 25 °C unless otherwise specified)

Symbol	Parameters	Test conditions	Min.	Typ.	Max.	Unit
t_{rr}	Reverse recovery time	I_F = 0.5 A, I_R = 1 A,I_{RR} = 0.25 A	-		65	ns
		I_F = 1 A, V_R = 30 V, dI_F/dt = 50 A/µs	-	65	90	
I_{RM}	Reverse recovery current	I_F = 30 A, V_R = 400 V, dI_F/dt = 100 A/µs	-	11.5	16	A
t_{fr}	Forward recovery time	I_F = 30 A, dI_F/dt = 100 A/µs, V_{FR} = 1.1 $V_{F(max.)}$	-		500	ns
V_{FP}	Forward recovery voltage	I_F = 30 A, dI_F/dt = 100 A/µs, V_{FR} = 1.1 $V_{F(max.)}$	-	2.5		V

1.1 Characteristics (curves)

Figure 1. Conduction losses versus average forward current (square waveform)

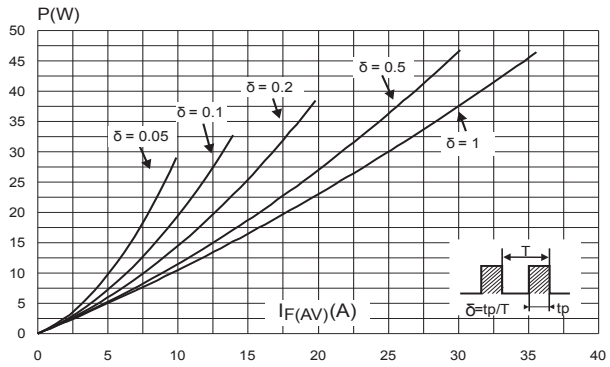


Figure 2. Conduction losses versus average forward current (sinusoidal waveform)

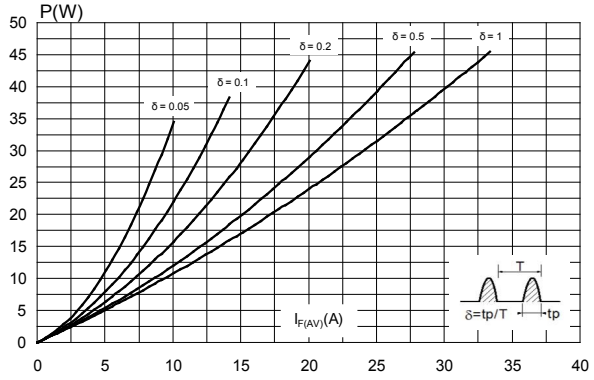


Figure 3. Forward voltage drop versus forward current

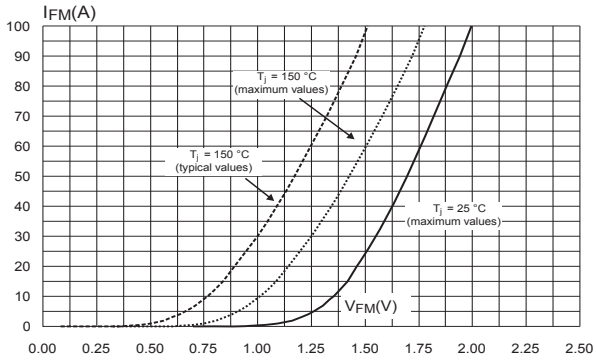


Figure 4. Relative variation of thermal impedance junction to case versus pulse duration

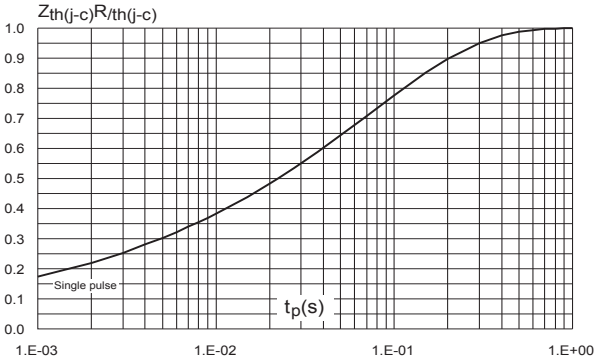


Figure 5. Peak reverse recovery current versus dI_F/dt (typical values)

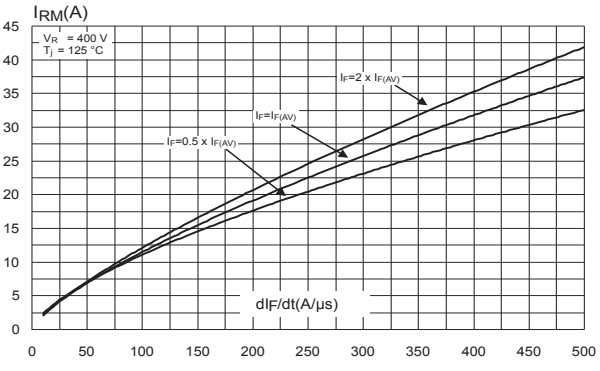


Figure 6. Reverse recovery time versus dI_F/dt (typical values)

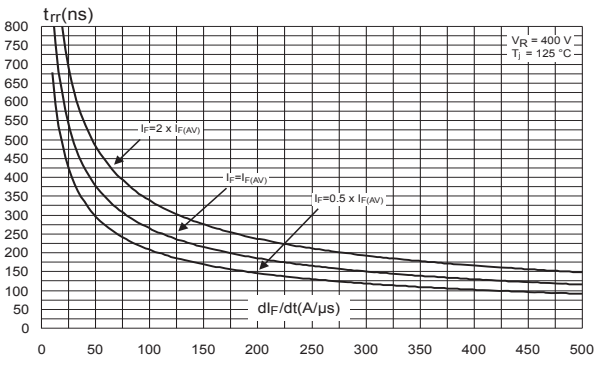


Figure 7. Reverse recovery charges versus dI_F/dt (typical values)

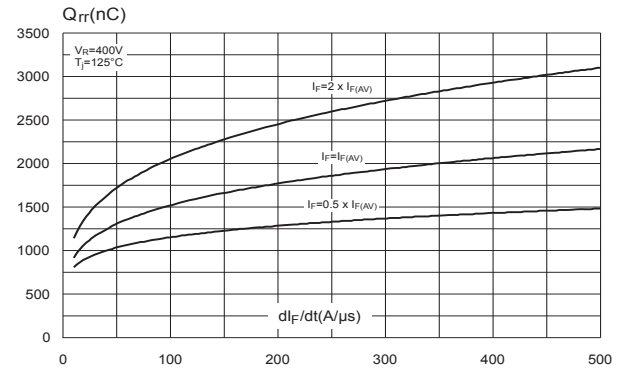


Figure 8. Reverse recovery softness factor versus dI_F/dt (typical values)

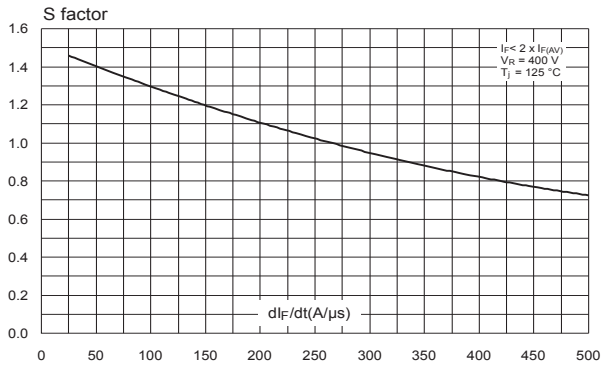


Figure 9. Relative variations of dynamic parameters versus junction temperature

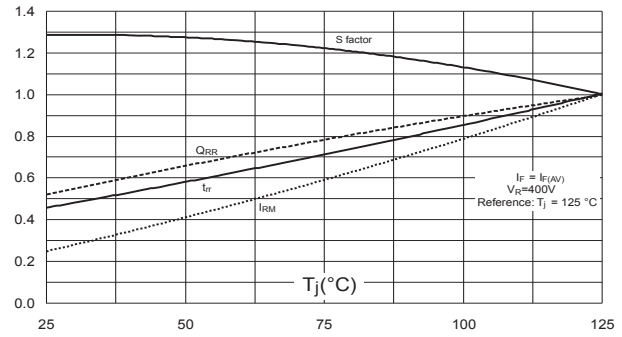


Figure 10. Transient peak forward voltage versus dI_F/dt (typical values)

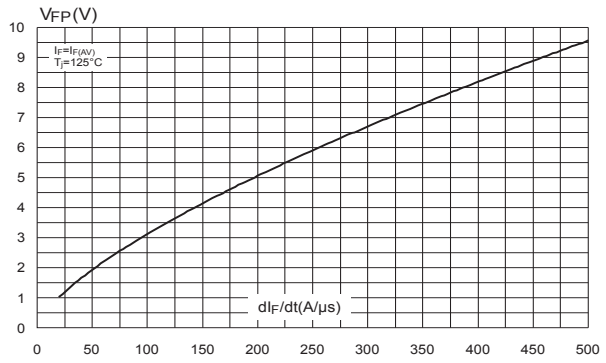


Figure 11. Forward recovery time versus dI_F/dt (typical values)

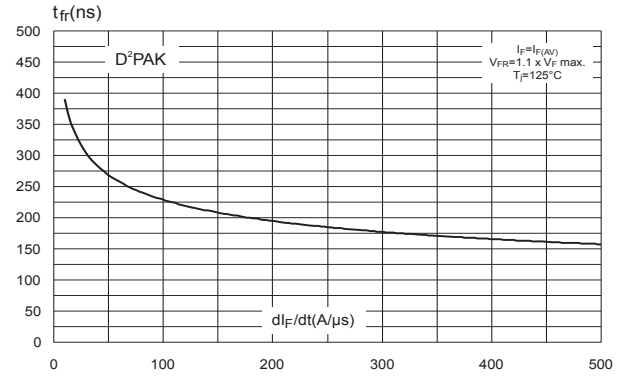


Figure 12. Junction capacitance versus reverse voltage applied (typical values)

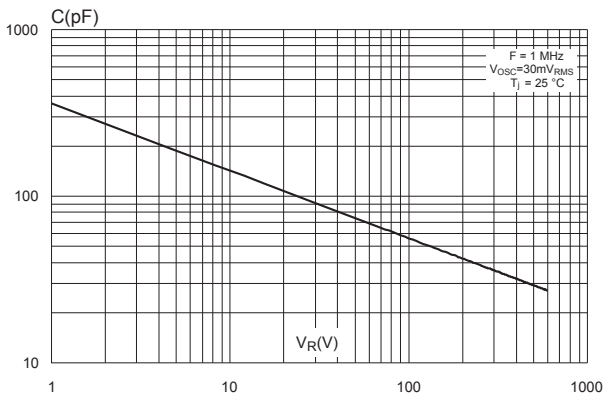
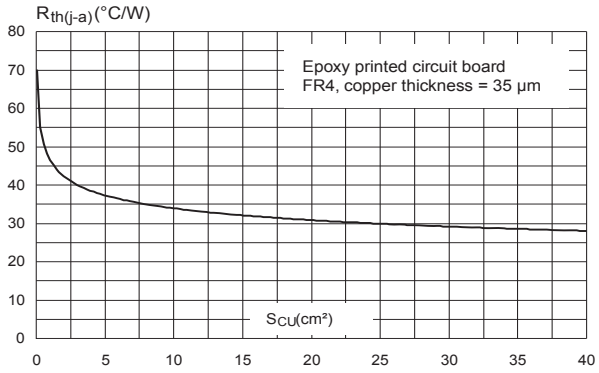


Figure 13. Thermal resistance junction to ambient versus copper surface under each lead (typical values)



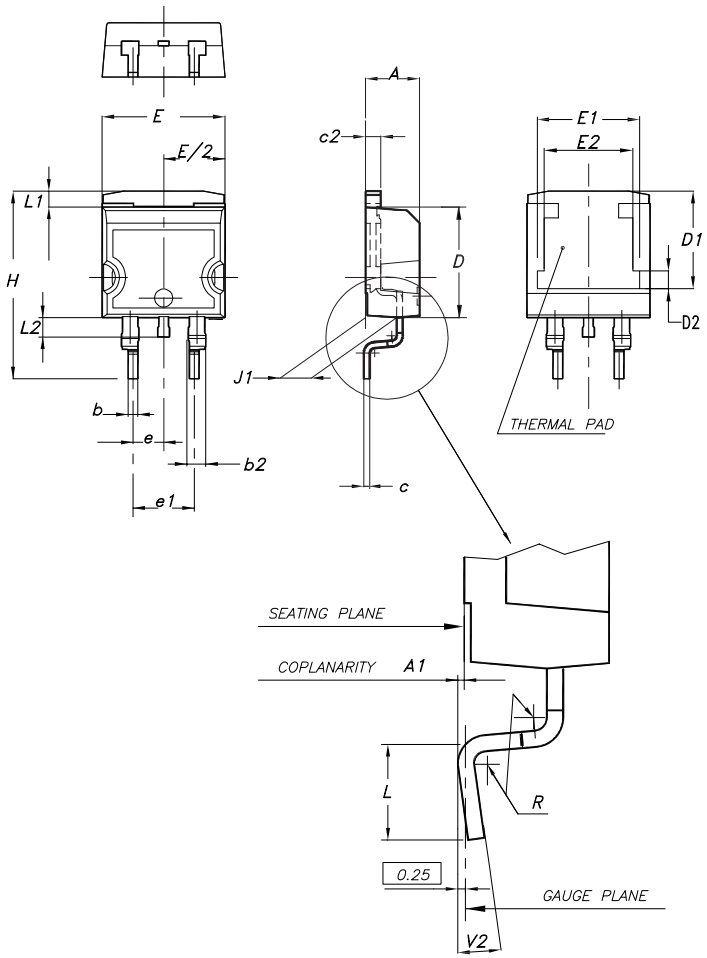
2 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK packages, depending on their level of environmental compliance. ECOPACK specifications, grade definitions and product status are available at: www.st.com. ECOPACK is an ST trademark.

2.1 D²PAK package information

- Epoxy meets UL94, V0.
- Cooling method: by conduction (C)

Figure 14. D²PAK package outline

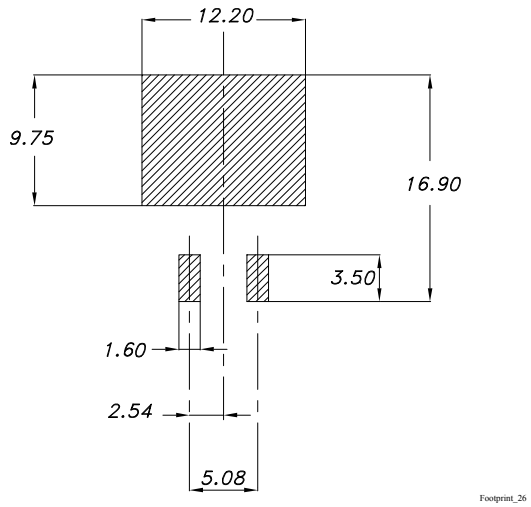


Note: This package drawing may slightly differ from the physical package. However, all the specified dimensions are guaranteed.

Table 5. **D²PAK package mechanical data**

Ref.	Dimensions					
	Millimeters			Inches (for reference only)		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	4.40		4.60	0.173		0.181
A1	0.03		0.23	0.001		0.009
b	0.70		0.93	0.028		0.037
b2	1.14		1.70	0.045		0.067
c	0.45		0.60	0.018		0.024
c2	1.23		1.36	0.048		0.053
D	8.95		9.35	0.352		0.368
D1	7.50	7.75	8.00	0.295	0.305	0.315
D2	1.10	1.30	1.50	0.043	0.051	0.060
E	10.00		10.40	0.394		0.409
E1	8.30	8.50	8.70	0.335	0.343	0.346
E2	6.85	7.05	7.25	0.266	0.278	0.282
e		2.54			0.100	
e1	4.88		5.28	0.190		0.205
H	15.00		15.85	0.591		0.624
J1	2.49		2.69	0.097		0.106
L	2.29		2.79	0.090		0.110
L1	1.27		1.40	0.049		0.055
L2	1.30		1.75	0.050		0.069
R		0.40			0.015	
V2	0°		8°	0°		8°

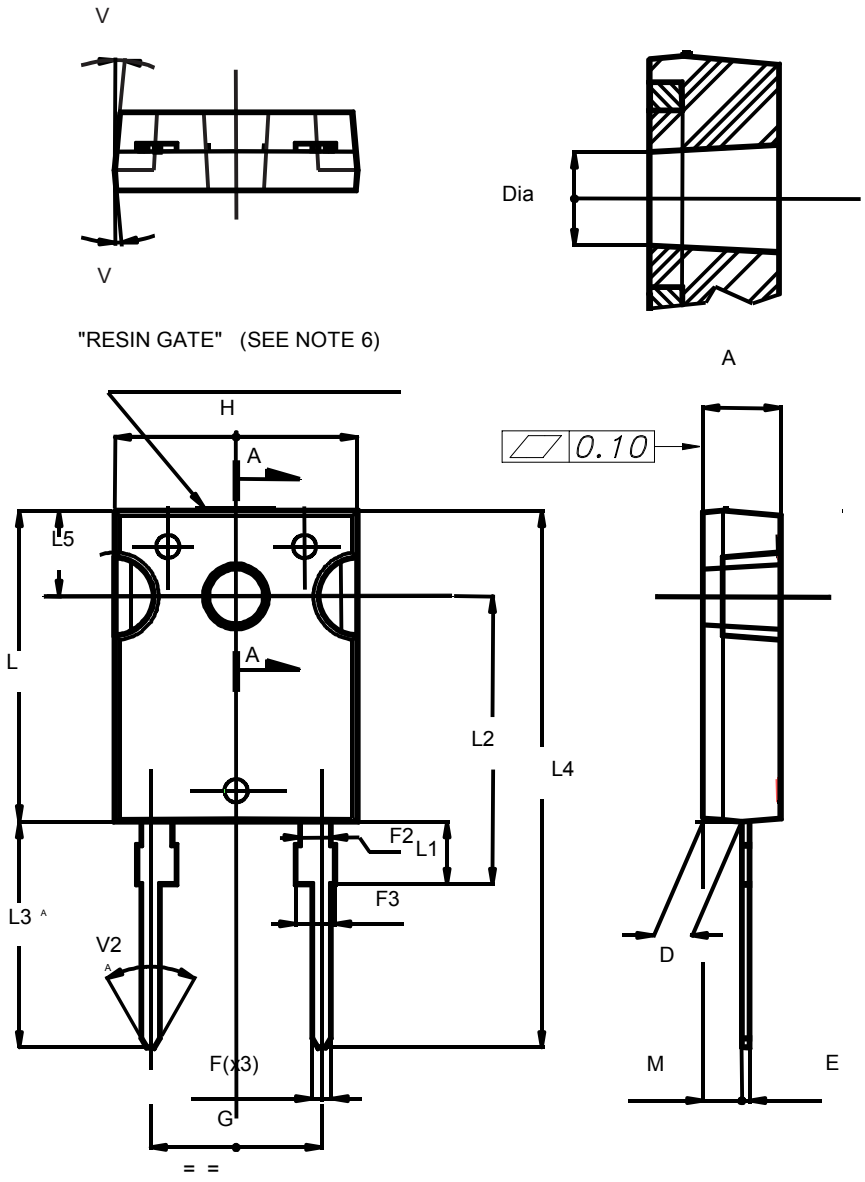
Figure 15. **D²PAK recommended footprint (dimensions are in mm)**



2.2 DO-247 package information

- Epoxy meets UL94, V0
- Cooling method: by conduction (C)
- Recommended torque value: 0.8 N·m
- Maximum torque value: 1.0 N·m

Figure 16. DO-247 package outline



Note: This package drawing may slightly differ from the physical package. However, all the specified dimensions are guaranteed.

Figure 17. **DO-247 package min-max drawing**

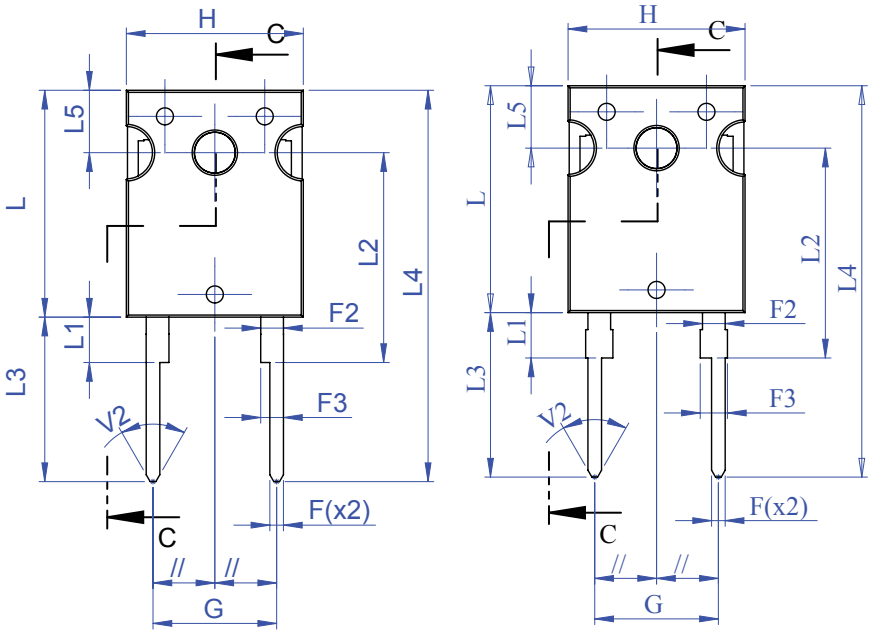


Table 6. **DO-247 package mechanical data**

Ref.	Dimensions					
	Millimeters			Inches (for reference only)		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	4.85		5.15	0.1909		0.2027
D	2.2		2.6	0.0866		0.1023
E	0.4		0.8	0.0157		0.0314
F	1		1.4	0.0393		0.0551
F2		2			0.0787	
F3	2		2.4	0.0787		0.0944
G		10.9			0.4291	
H	15.45		15.75	0.6082		0.6200
L	19.85		20.15	0.7814		0.7933
L1	3.7		4.3	0.1456		0.1692
L2		18.5			0.7283	
L3	14.2		14.8	0.5590		0.5826
L4		34.6			1.3622	
L5		5.5			0.2165	
M	2		3	0.0787		0.1181
V		5°			5°	
V2		60°			60°	
Diam.	3.55		3.65	0.1397		0.1437

3 Ordering information

Table 7. **Ordering information**

Order code	Marking	Package	Weight	Base qty.	Delivery mode
STTH30L06GY-TR	STTH30L06GY	D²PAK	1.48 g	1000	Tape and reel
STTH30L06WY	STTH30L06WY	DO-247	4.36 g	30	Tube

Revision history

Table 8. **Document revision history**

Date	Version	Changes
24-Oct-2012	1	First issue.
21-Sep-2020	2	Updated package information. Added Figure 2. Conduction losses versus average forward current (sinusoidal waveform).
21-Oct-2020	3	Added Figure 17.